

FY2025

Second Quarter Financial Results

October 29, 2025

DISCLAIMER

Statements in this PowerPoint with respect to DISCO's current strategies, plans, estimates, and beliefs and other statements that are not historical facts are forward-looking statements about the future performance of DISCO. These statements are based on management's assumptions and beliefs in light of the information currently available to it and therefore you should not place undue reliance on them. DISCO cautions you that a number of important factors could cause actual results to differ materially from those discussed in the forward-looking statements, and you should not make decision on your investment thoroughly based on these statements. Such factors include, but not limited to, (i) general economic conditions and levels of demand in DISCO's markets; (ii) developments in technology and resulting changes in semiconductor and/or electronic component manufacturing process; (iii) levels of capital investment for manufacturing semiconductors and/or electronic components; (iv) expansions of the area for products and technologies using semiconductors and/or electronic components and its expanding speed; (v) DISCO's ability to continue to offer products and services corresponding to developments of new semiconductors and/or electronic components and new technologies for manufacturing them; (vi) exchange rates, particularly between the yen, the U.S. dollar, and the euro, and other currencies.

FY2025 2Q Earnings Results



Billions of Yen	FY2025	FY2025 1Q	QoQ		FY2024 2Q	YoY	
	2Q		Amount	(%)		Amount	(%)
Net Sales	104.6	89.9	14.7	16.4%	96.2	8.4	8.7%
Gross Profit	72.7	61.3	11.5	18.8%	69.0	3.7	5.4%
Gross Profit Margin	69.5%	68.1%	1.4p	-	71.7%	-2.2p	-
SG&A	28.4	26.8	1.6	5.9%	26.5	1.9	7.2%
Operating Income	44.4	34.5	9.9	28.7%	42.6	1.8	4.3%
Ordinary Income	45.5	34.0	11.5	33.7%	41.4	4.0	9.7%
Ordinary Income Margin	43.5%	37.8%	5.7p	-	43.0%	0.5p	-
Income before income taxes and minority interests	44.9	33.7	11.3	33.5%	41.3	3.6	8.7%
Net Income	32.1	23.8	8.4	35.3%	29.7	2.4	8.1%

Sales: QoQ Increased due to progress in equipment inspection/acceptance and steady consumable shipments
 GP margin: QoQ Increased due to increased profitability from high value-added products
 SG&A: QoQ Increased due to personnel and R&D expenses

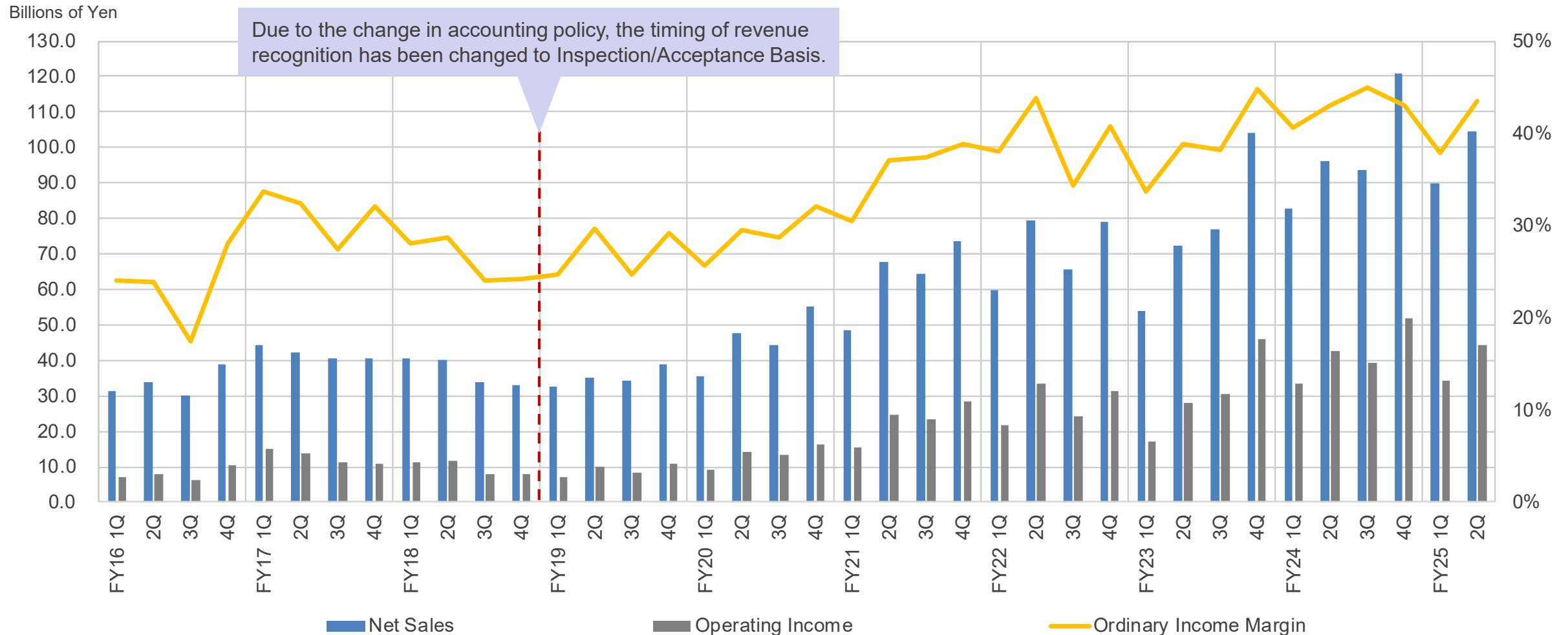
FY2025 1H Earnings Results



Billions of Yen	FY2025 1H	FY2024 1H	YoY	
			Amount	(%)
Net Sales	194.5	179.0	15.5	8.7%
Gross Profit	134.0	126.7	7.3	5.7%
Gross Profit Margin	68.9%	70.8%	-1.9p	-
SG&A	55.1	50.8	4.4	8.6%
Operating Income	78.9	76.0	2.9	3.8%
Ordinary Income	79.5	75.1	4.4	5.9%
Ordinary Income Margin	40.8%	41.9%	-1.1p	-
Income before income taxes and minority interests	78.6	74.8	3.8	5.1%
Net Income	55.9	53.4	2.5	4.6%

Net Sales: Increased mainly due to an increase in shipments for generative AI and progress in equipment inspection/acceptance
 GP margin: Slight decrease in profitability due to product composition and the exchange rate
 SG&A: Increased mainly due to personnel and R&D expenses

Quarterly Financial Results



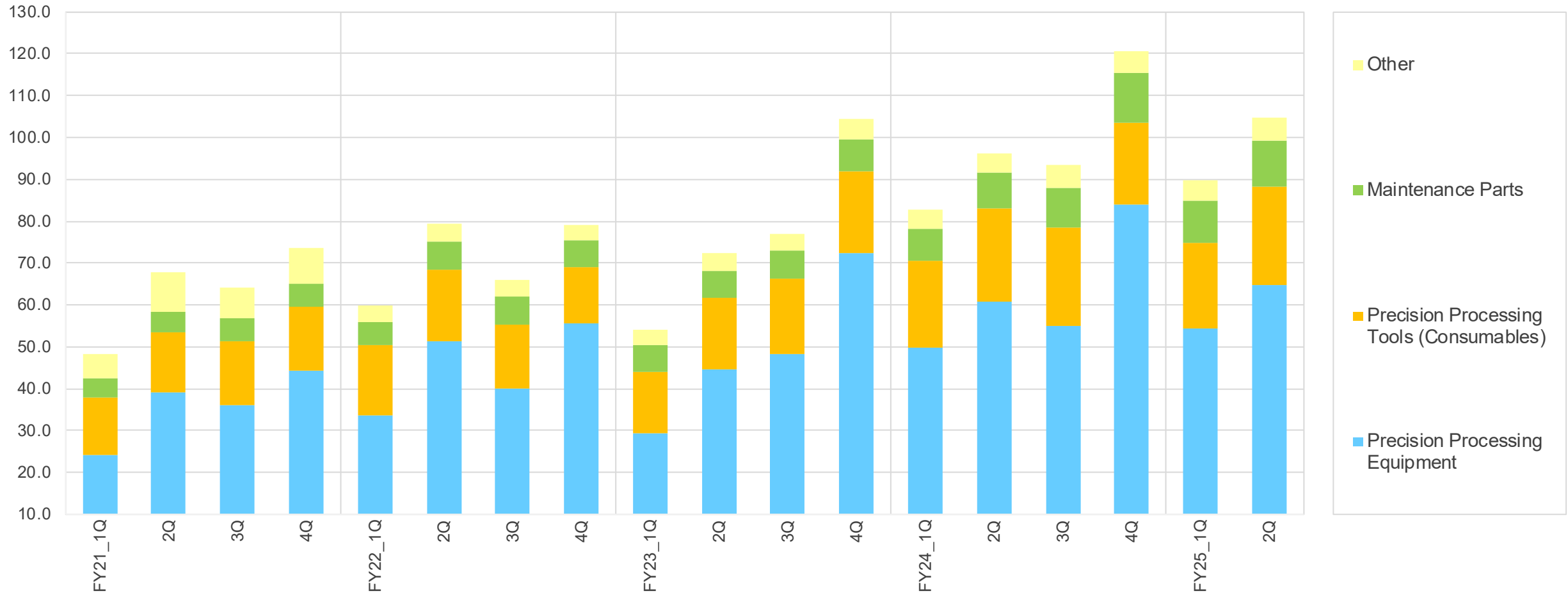
FY25_2Q Operating income margin 42.4%, Ordinary income margin 43.5%, Net income margin 30.7%

Note: Detailed data is available in the Consolidated Financial Information on DISCO's website.

Quarterly Sales Breakdown by Product



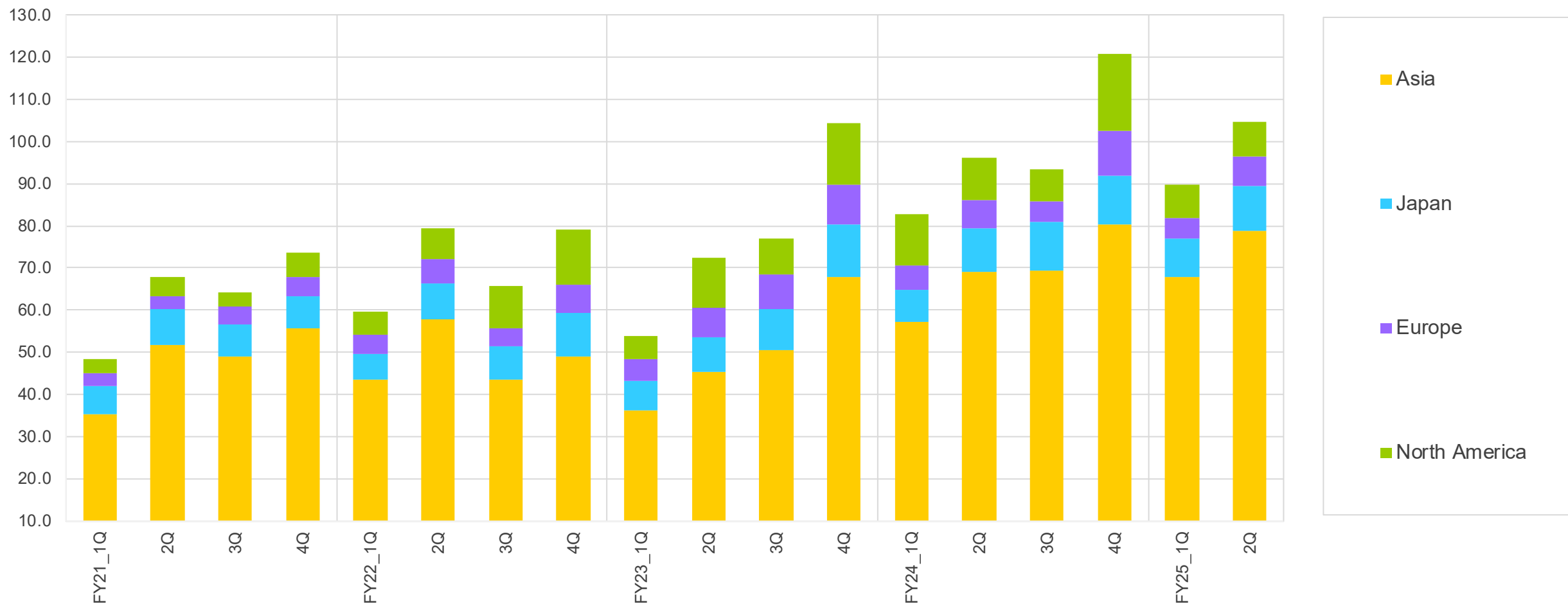
Billions of Yen



Note: Composition percentages are available in the “Consolidated Financial Information” on DISCO’s website.

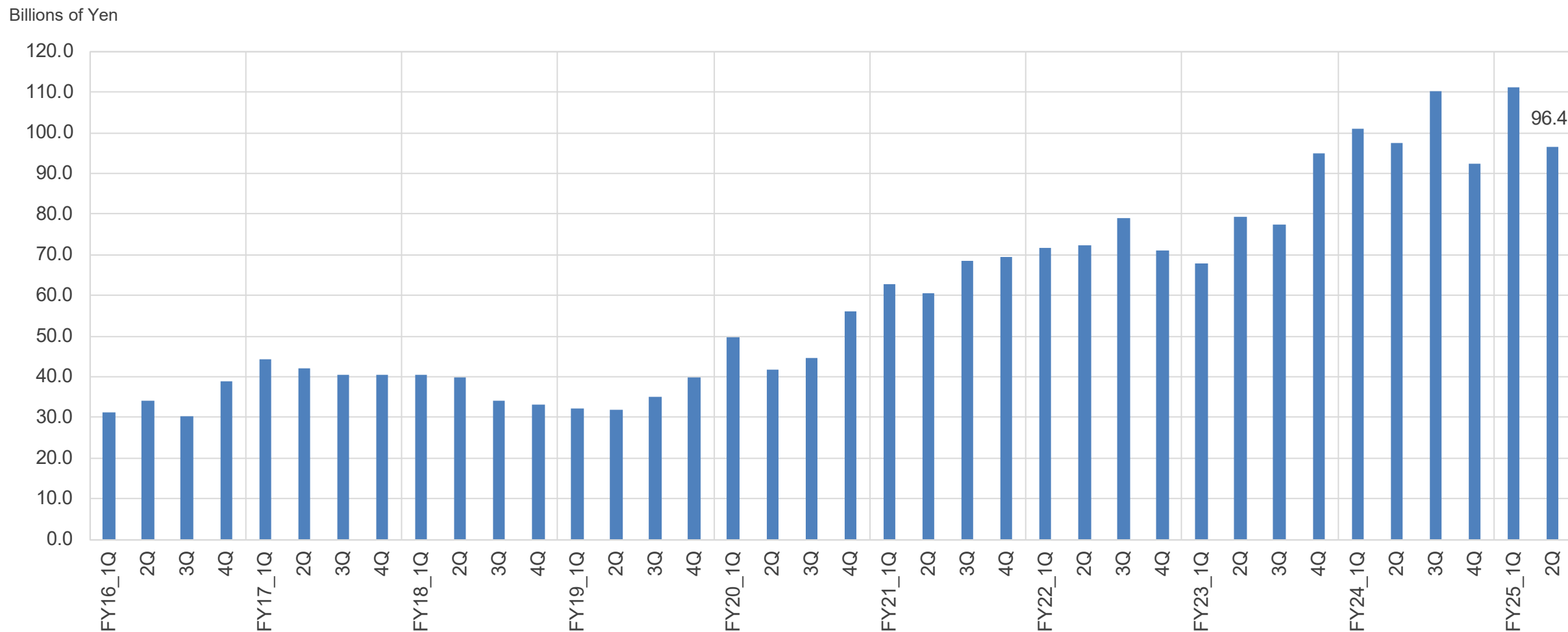
Quarterly Sales Breakdown by Region

Billions of Yen



FY25_2Q Overseas sales ratio: 89.9%

Quarterly Shipments

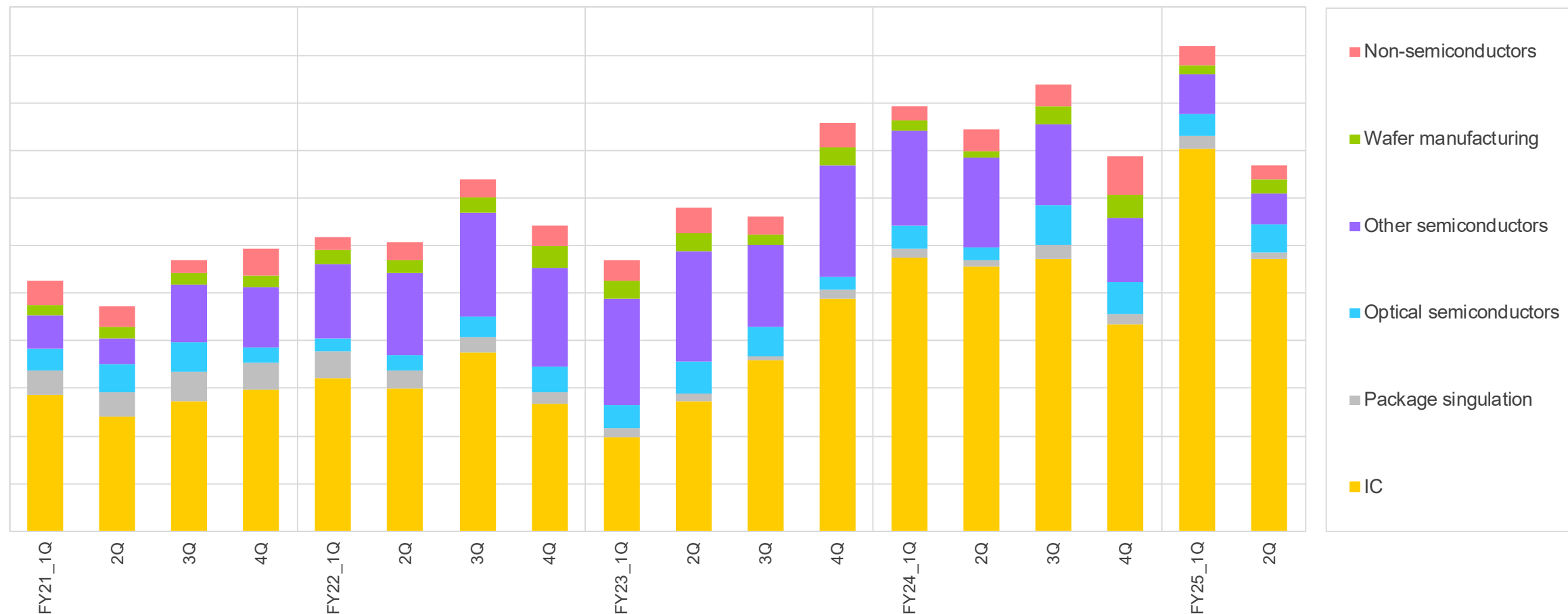


FY25_2Q Shipment volume: approx. 96.4 billion yen

Precision Processing Equipment: Sales by Application

Shipment Basis

Precision Processing Equipment



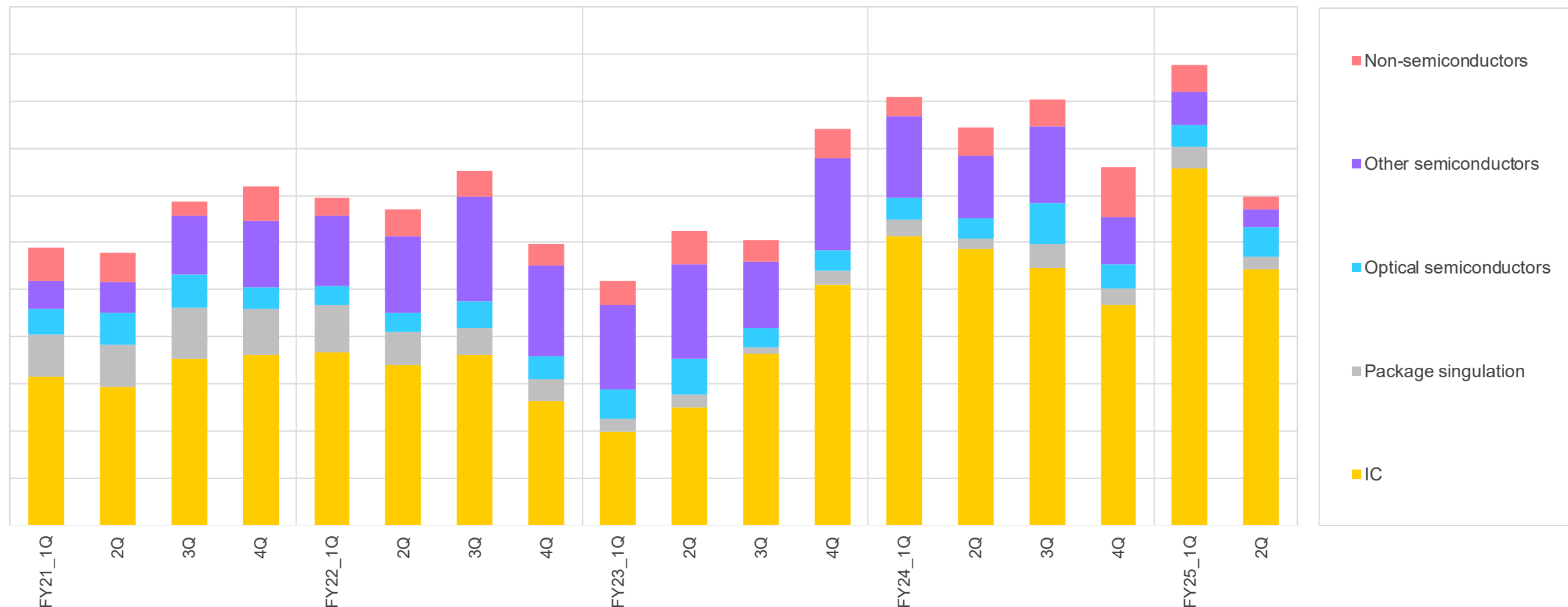
QoQ
YoY

Decreased for IC in reaction to the concentrated shipments in the previous quarter
Decreased mainly for power semiconductors (other semiconductors)

Dicer: Sales by Application

Shipment Basis

Dicer



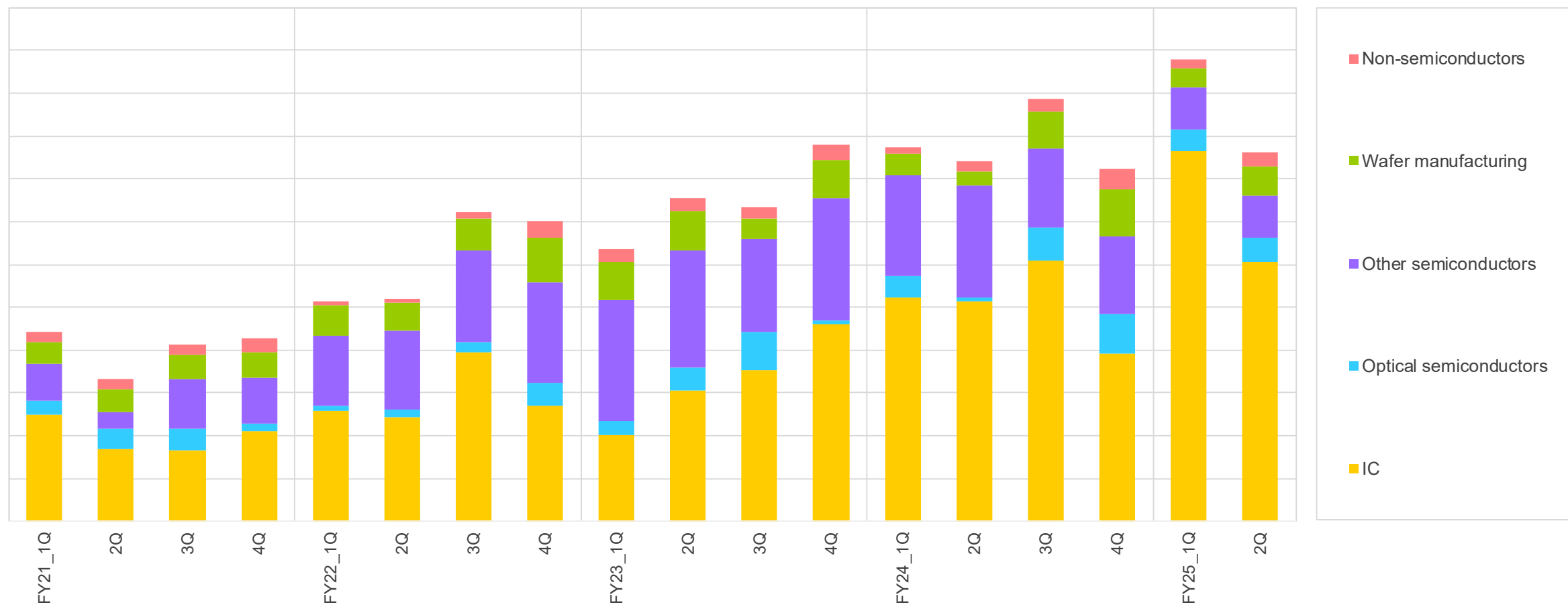
QoQ
YoY

Decreased for IC in reaction to the concentrated shipments in the previous quarter
Decreased for IC and power semiconductors (other semiconductors)

Grinder: Sales by Application

Shipment Basis

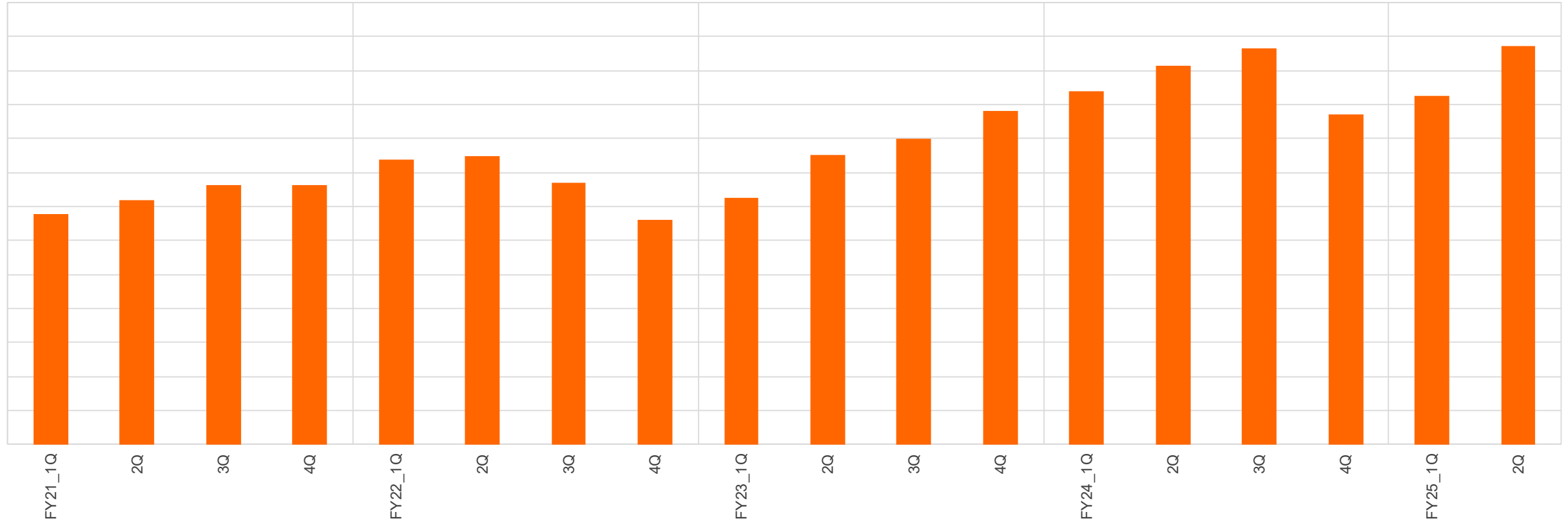
Grinder



QoQ
YoY

Decreased for IC in reaction to the concentrated shipments in the previous quarter
Although a decrease for power semiconductors (other semiconductors) was seen, increased for IC mainly for generative AI

Precision Processing Tools Sales (Consumables)



Increased from the previous quarter driven by factors such as customer equipment operating rates, and hit a record high

Balance Sheet (Summary)

Billions of Yen	FY2025 2Q	FY2025 1Q	Amount
Cash and deposits	222.9	198.5	24.4
Notes and account receivable	53.8	48.0	5.8
Inventories	138.7	141.1	-2.4
Total current assets	421.6	391.1	30.6
Property, plant and equipment	211.0	206.6	4.4
Total noncurrent assets	229.7	229.0	0.7
Total assets	651.4	620.1	31.3
Current liabilities	132.7	134.1	-1.4
Noncurrent liabilities	1.0	1.0	-0.1
Total liabilities	133.7	135.2	-1.5
Total net assets	517.7	484.9	32.8
Total liabilities and net assets	651.4	620.1	31.3
Equity Ratio	79.2%	78.0%	1.2p

Total assets: Although a decrease in inventories was seen, cash and deposits increased
 Liabilities: Although income taxes payable and others increased, provision for bonuses and accounts payable decreased
 Net assets: Increased mainly for retained earnings

Cash Flow (Summary)

Billions of Yen	FY2025 1H	FY2024 1H	Amount
Net cash provided by (used in) operating activities	39.7	60.9	-21.3
Income before income taxes and minority interests	78.6	74.8	3.8
Depreciation and amortization	7.0	5.7	1.3
Decrease (increase) in notes and accounts receivable-trade	-9.4	5.1	-14.5
Decrease (increase) in inventories	0.8	-16.7	17.5
Increase (decrease) in notes and accounts payable-trade	-8.1	-0.5	-7.6
Income taxes (paid) refund	-31.3	-19.9	-11.4
Others	2.2	12.5	-10.3
Net cash provided by (used in) investing activities	-15.3	-7.1	-8.2
Purchase of property, plant and equipment	-14.9	-7.1	-7.8
Free cash flow	24.4	53.8	-29.4
Net cash provided by (used in) financing activities	-31.2	-24.9	-6.3
Cash dividends paid	-31.3	-25.0	-6.3
Net change in of cash and cash equivalents	-6.3	28.1	-34.3
Cash and cash equivalents at beginning of period	229.2	215.5	13.7
Cash and cash equivalents at end of period	222.9	243.6	-20.7

- Sales cash flow: approx. 39.6 B yen (increase)
Increased mainly due to income before taxes
 - Investment cash flow: approx. JPY 15.2 B (decrease)
Decreased mainly due to acquisition of property, plant and equipment
 - Free cash flow: approx. JPY 24.4 B (increase)
 - Financial cash flow: approx. JPY 31.2 B (decrease)
Decreased mainly due to dividend payout
- Cash balance as of the end of September:
approx. JPY 222.9 B

Earnings Forecast 3Q FY2025



Billions of Yen

Forecast

	FY24 1Q	2Q	3Q	4Q	FY25 1Q	2Q	3Q
Net Sales	82.8	96.2	93.6	120.7	89.9	104.6	92.6
Operating Income	33.4	42.6	39.1	51.7	34.5	44.4	32.8
Ordinary Income	33.6	41.4	42.0	51.9	34.0	45.5	32.9
Net Income	23.7	29.7	31.8	38.6	23.8	32.1	24.4
Operating Income Margin	40.3%	44.2%	41.8%	42.9%	38.3%	42.4%	35.4%
Ordinary Income Margin	40.6%	43.0%	44.9%	43.0%	37.8%	43.5%	35.5%
Net Income Margin	28.6%	30.9%	34.0%	32.0%	26.4%	30.7%	26.3%
Shipment Figures	101.1	97.6	110.3	92.5	111.1	96.4	101.6

*Rounded to the nearest 100 million yen

Assumed exchange rate for 3Q (Oct-Dec): 1 US dollar = 145 yen, 1 euro = 172 yen
 Currency sensitivity (annualized) US dollar: Approx. 1.6 billion yen, Euro: Approx. 0.1 billion yen

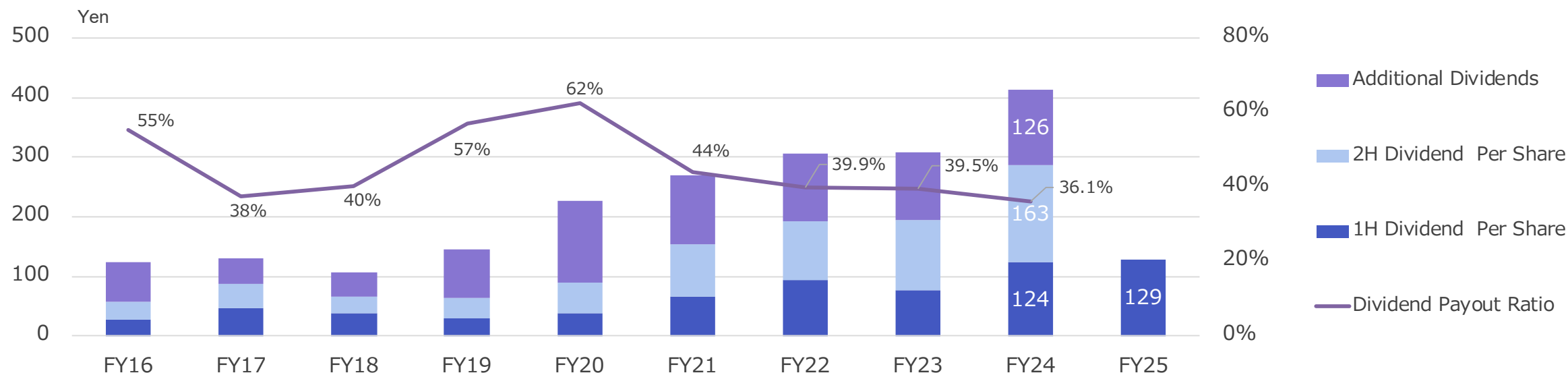
(Reference) Earnings forecast for the October to December period
 if converted using the same exchange rate as in the previous quarter
 Net sales: Approx. 1,032 yen Shipment figures: Approx. 940 yen

Dividend Policy

- Decisions concerning the distribution of surpluses are made at the general shareholders meetings, in the case of final dividends, and by the Board of Directors, in the case of interim dividends.
- 1. Adopting a performance-linked dividend policy and aiming at giving clearer priority to shareholder returns, our target dividend payout ratio is 25% of the consolidated half-yearly net income. There will be interim and final dividends, each of which will be equivalent to 25% of the half-yearly consolidated net income.
- 2. Irrespective of the level of income, a reliable dividend of ¥10 per half-year will be maintained. This means that the minimum yearly dividend will be ¥20.
- 3. Unless there is a loss, if the year-end balance of cash and deposits after payment of dividends and income taxes is greater than the projected funding requirements for the acquisition of technology resources, such as through patent purchases and investments in venture businesses, facility expansion, the retirement of interest-bearing debt, and other purposes, one-third of that surplus will be added to dividends.

[Remarks]

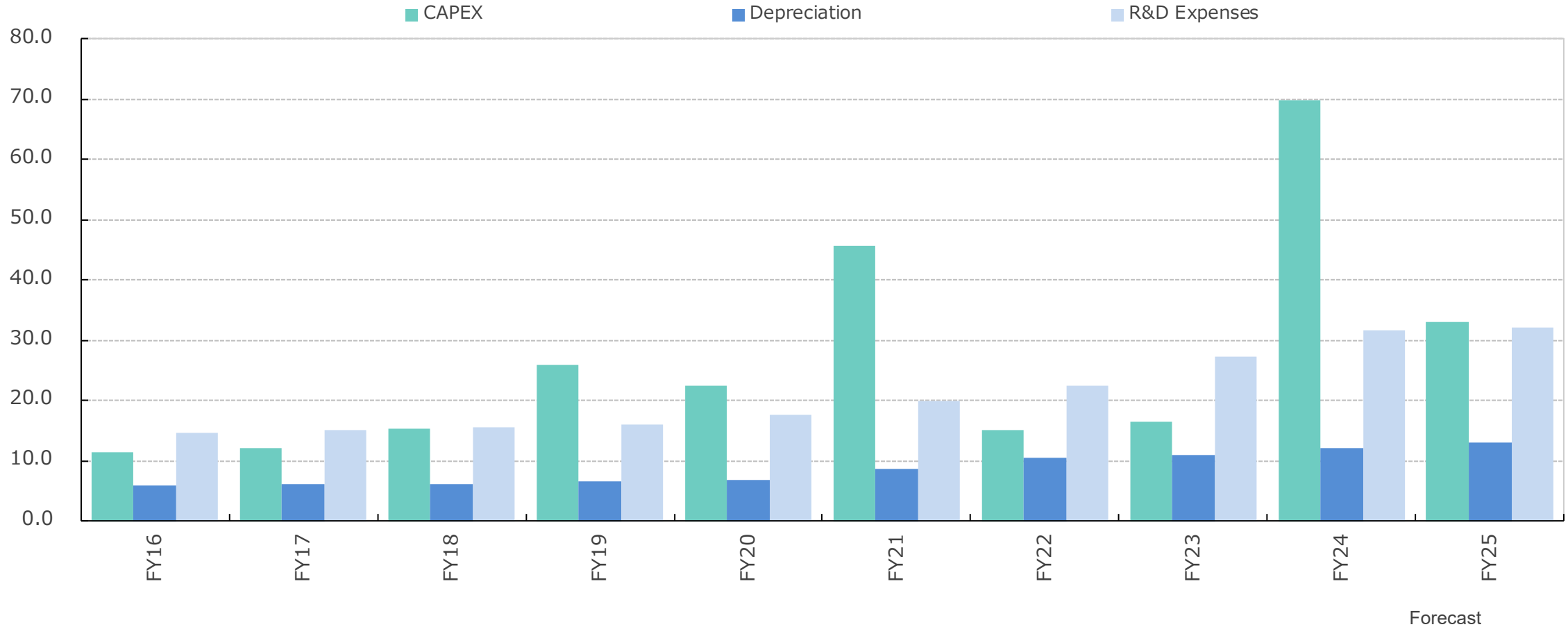
The ¥20 payout stipulated in our stable dividend policy may be reviewed if there are consolidated net losses for three consecutive years.



FY25 Interim (actual) 129 yen Year-end: undecided

*The Company implemented a stock split in the proportion of 1 share into 3 shares effective as of April 1, 2023
(The dividend trend before FY22 has been represented under the assumption that the applicable stock split has been done)

Billions of Yen

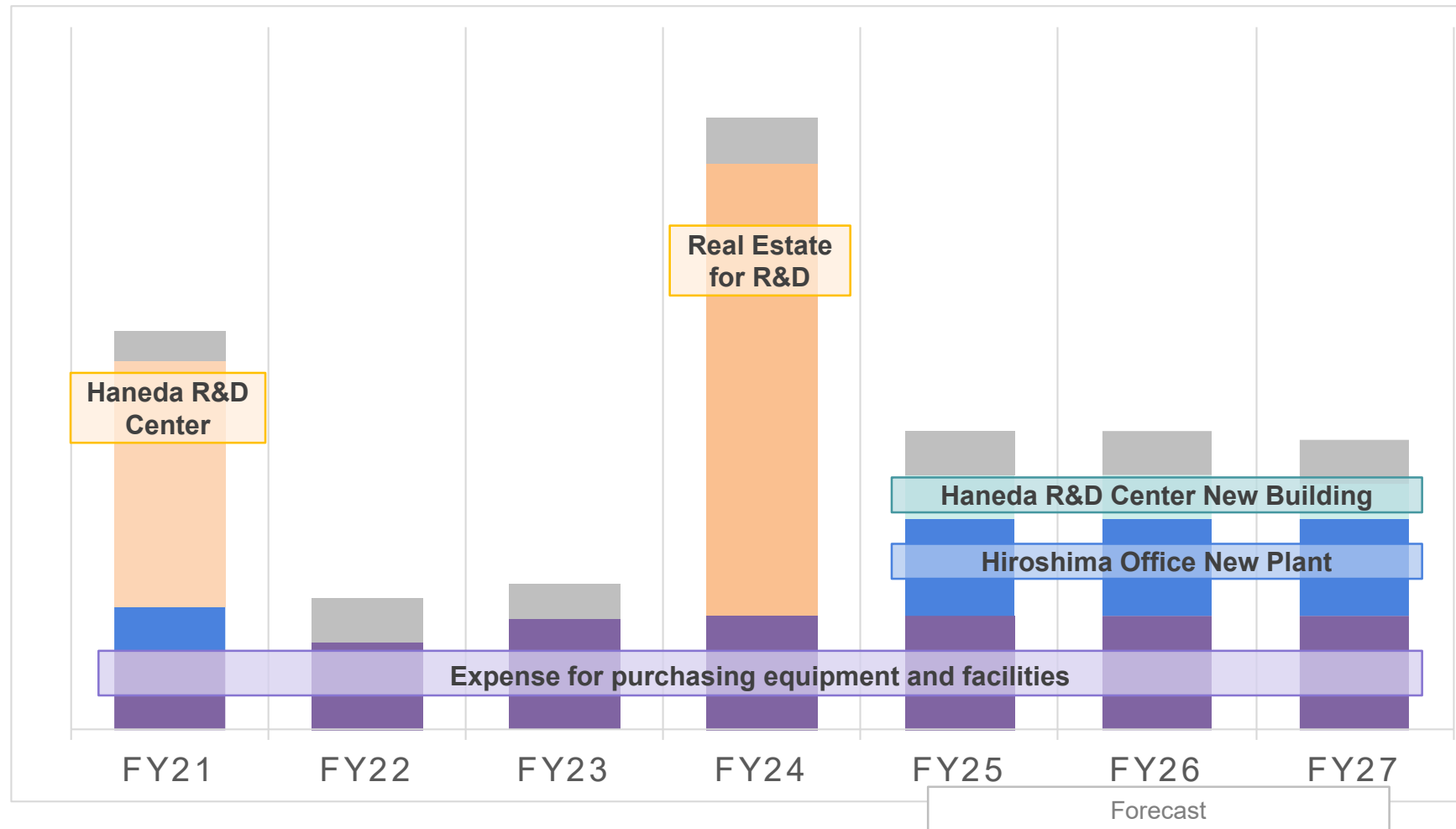


FY25 Forecast

CAPEX: Approx. 33 billion yen; including rationalization investment, reconstruction of the Haneda R&D Center, and construction of a new plant.

Depreciation: Approx. 13 billion yen

R&D Expenses: Approx. 32 billion yen; proactive research and development continues.



Real Estate for R&D:
Haneda R&D Center new building:
Hiroshima Works new plant:

Approx. 50 billion yen
Approx. 14 billion yen
Approx. 33 billion yen

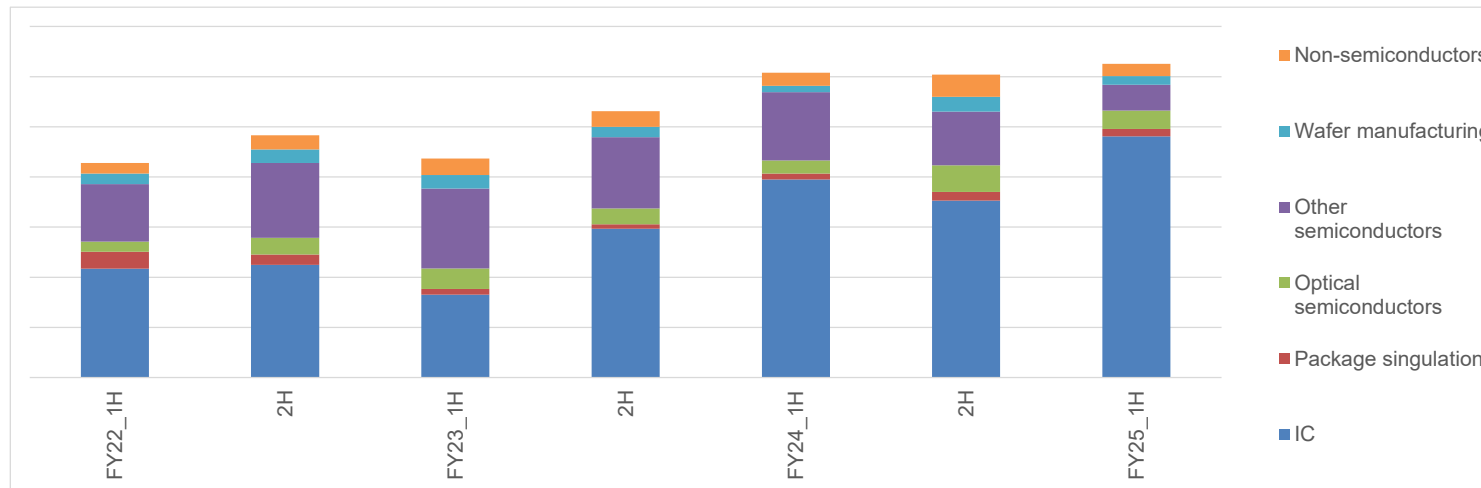
Payment timing: FY24
Payment timing: FY25~27
Payment timing: FY25~27

Shipment Basis

Product		Forecast FY25_3Q (QoQ)
	Blade dicers	-20%
	Laser Saws	25%
	Dicers	0%
	Grinders	25%
	Accessory Equipment	40%
Precision Processing Equipment		15%
Precision Processing Tools (Consumable)		0%
Others		-20%

■ Shipment Trend: Record high on a half-yearly basis.

Although demand for PCs, smartphones, and automotive applications was weak, equipment shipments for memory and logic remained high due to the demand for generative AI-related applications.

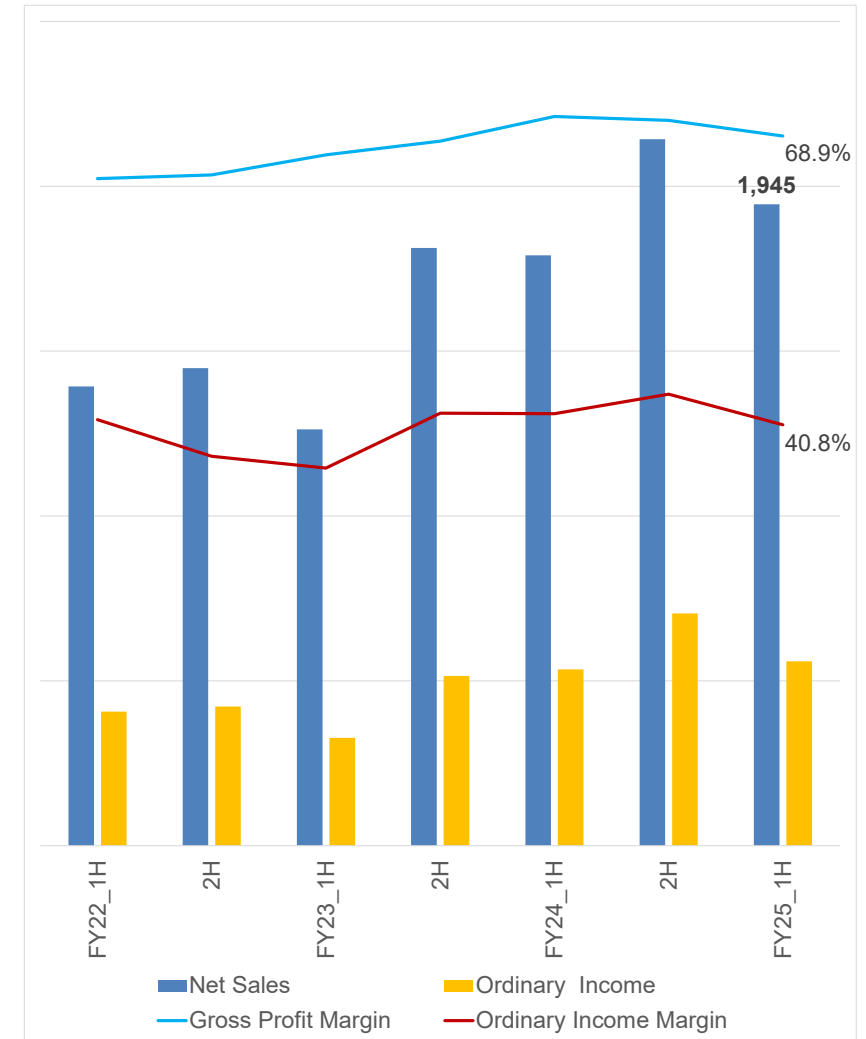


■ High value-added products continue to contribute to business performance

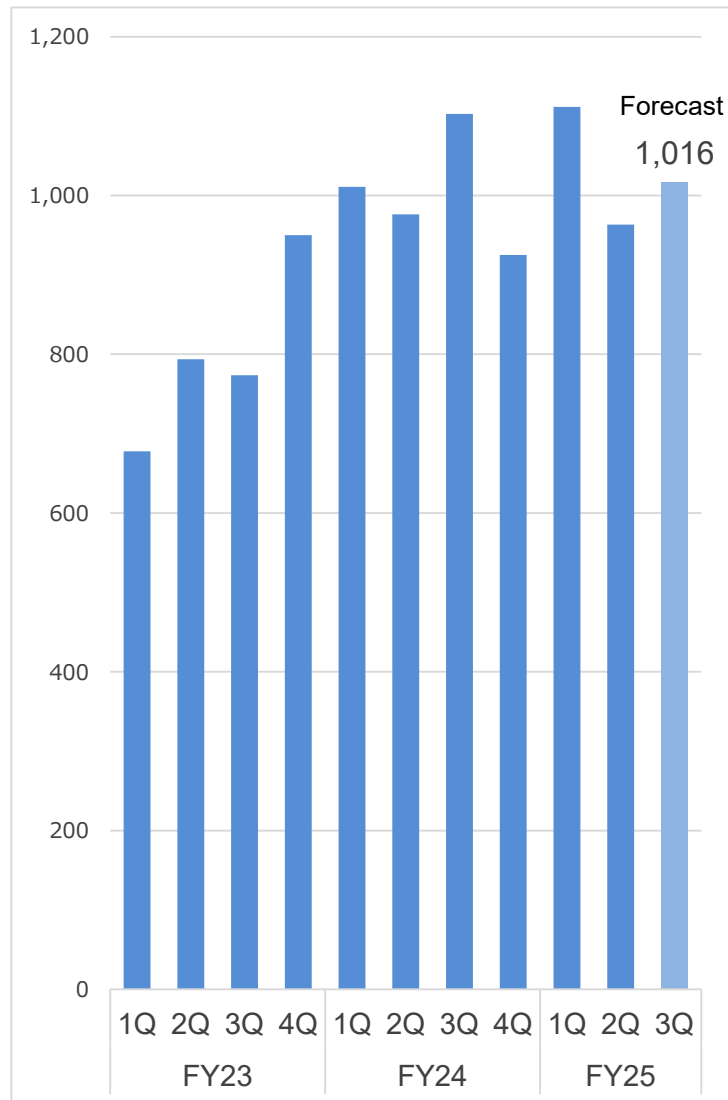
The GP margin saw a slight decrease in reaction to the exchange rate and previously high levels, but the ordinary income margin remained high at the 40% mark.

■ Interim dividends increased linked to business performance: 129 yen (124 yen last year)

Business Performance Trend (acceptance basis) (100 million yen)



Quarterly Shipment Total Trends
(100 million yen)



- **Equipment shipments for generative AI is expected to continue linked to factors such as final demand**
- **An increase in applications and full-scale ramp-up of advanced packaging is expected**
- **Handling changes in the business environment**
While responding to investment trends of semiconductor manufacturers, we will closely monitor changes and risks in the supply chain and procurement structure in light of the international situation
- **Fabrication is the source of competitiveness**
Based on our Fab-Important strategy, we will continue to proactively invest in facility expansion in order to strengthen competitiveness by integrating R&D and manufacturing (Haneda R&D Center new building, Hiroshima Works Gohara Plant, etc.)
- **A good corporate culture is the source of DISCO's strength**
DISCO continues to implement activities that will strengthen the company such as DISCO Values, Will Accounting, and PIM activities

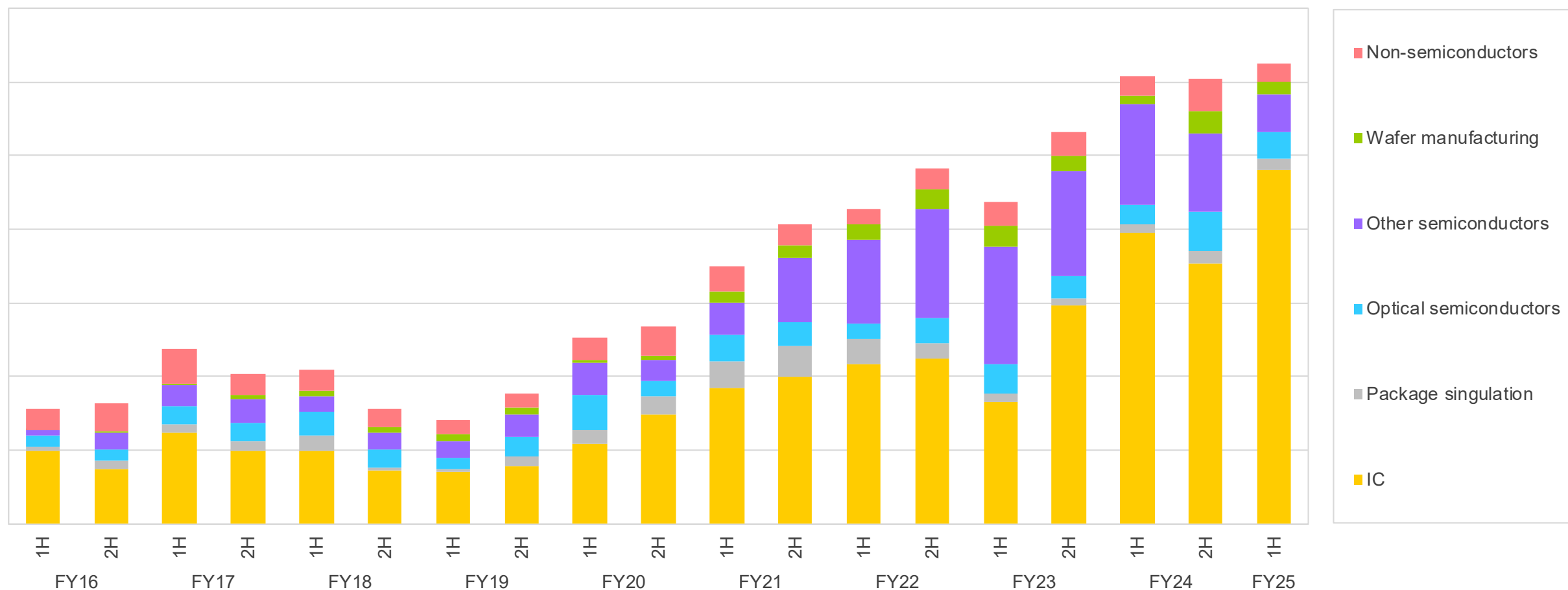
- Reference Data

Precision Processing Equipment: Sales by Application

Shipment Basis

Half-Year

Precision Processing Equipment



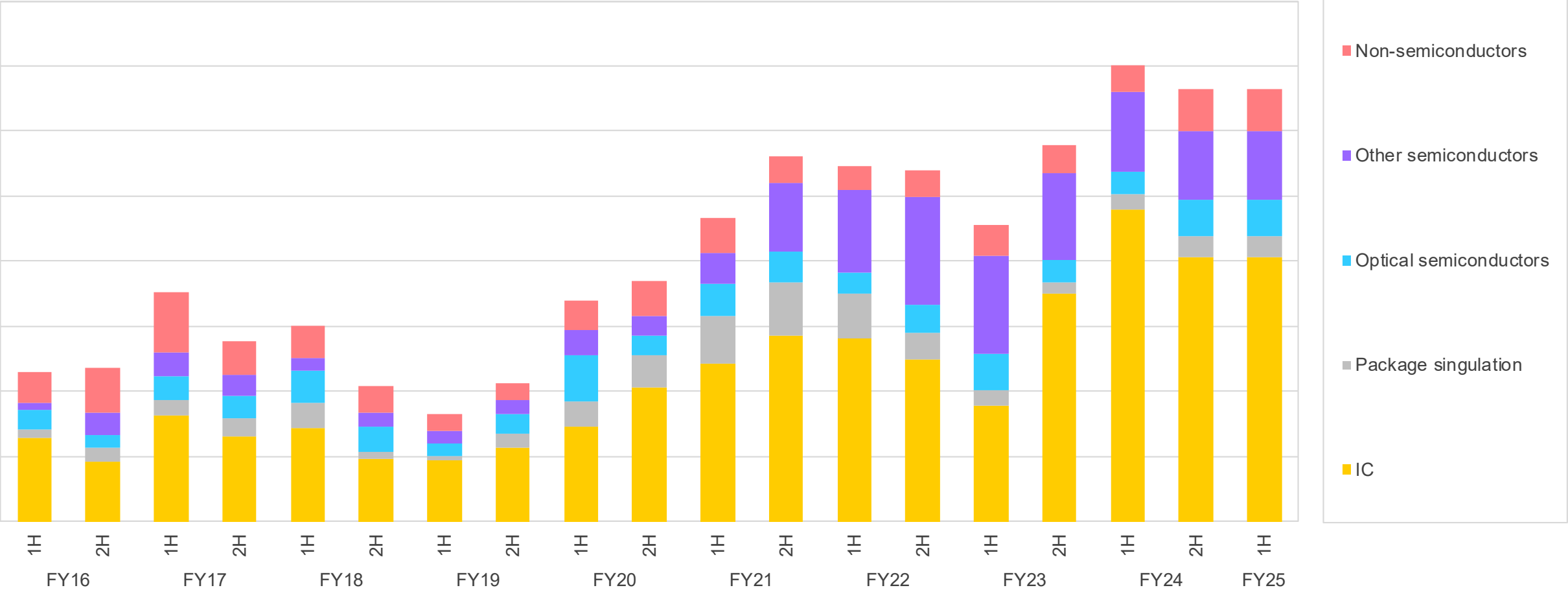
Dicer: Sales by Application



Shipment Basis

Half-Year

Dicer



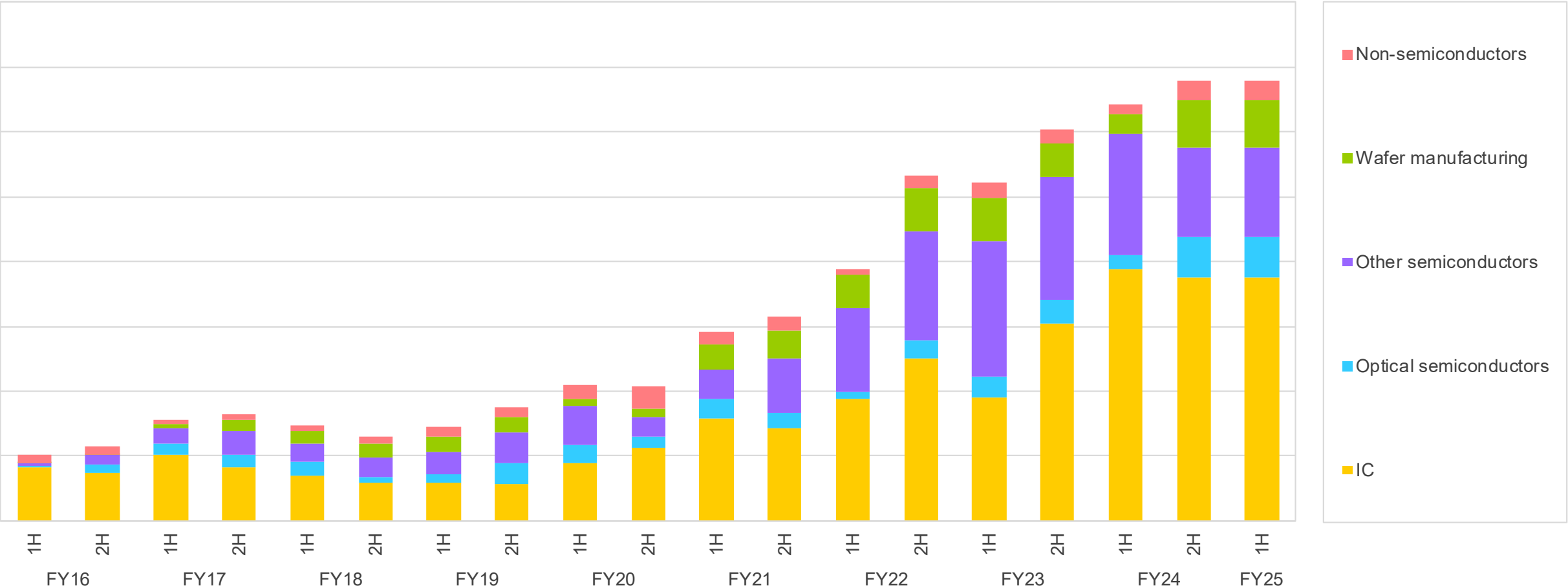
Grinder: Sales by Application



Shipment Basis

Half-Year

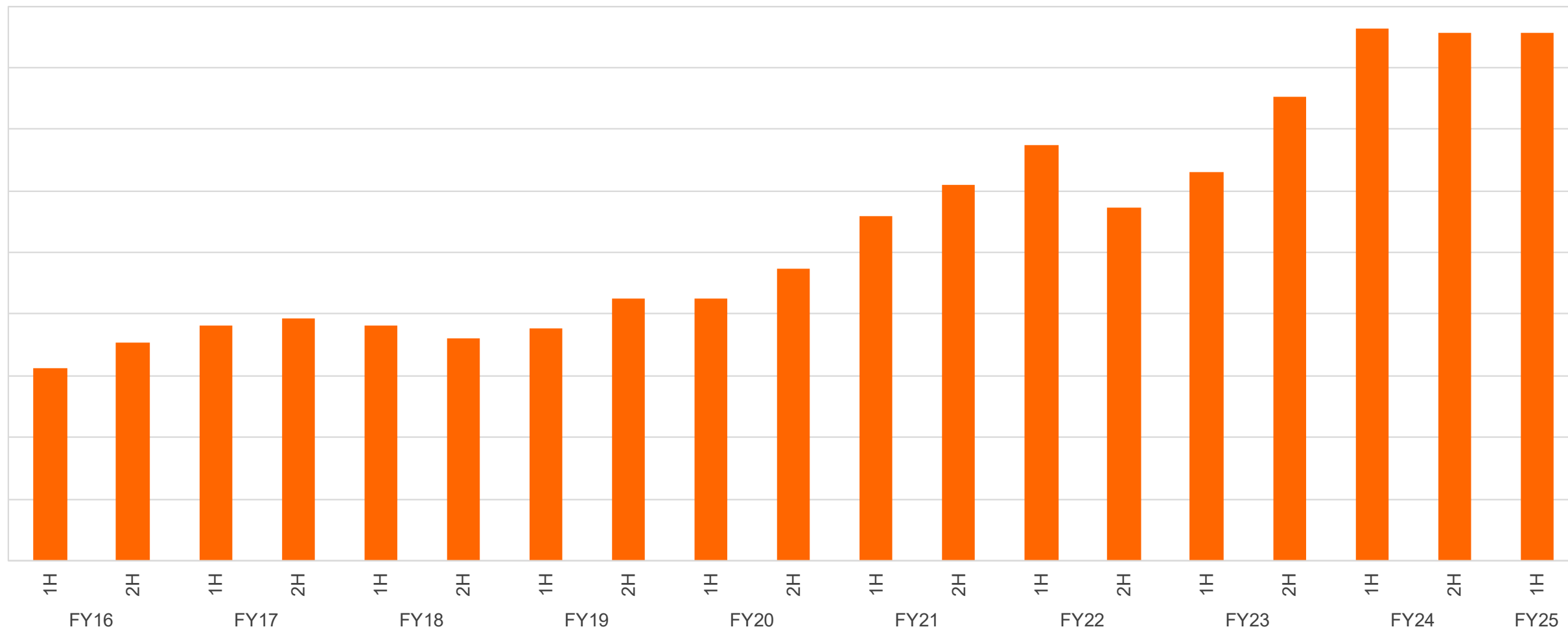
Grinder



Precision Processing Tools Sales (Consumables)

Shipment Basis

Half-Year



Reference Data

Shipment Basis

Product	2Q			1H	
	Composition	QoQ	YoY	Composition	YoY
Precision Processing Equipment	58%	-25%	-11%	63%	2%
Dicers	29%	-29%	-17%	32%	-5%
Blade Dicers	17%	-18%	6%	17%	5%
Laser Saws	12%	-39%	-36%	15%	-14%
Grinders	27%	-20%	2%	28%	13%
Accessory Equipment	3%	-37%	-40%	3%	-19%
Precision Processing Tools	24%	13%	1%	21%	0%
Others	18%	11%	46%	16%	26%
Total	100%	-13%	-1%	100%	4%

Shipment Basis

		FY24				FY25	
Product	Application	24-1Q	24-2Q	24-3Q	24-4Q	25-1Q	25-2Q
Dicers	IC	67%	69%	60%	62%	78%	78%
	Package singulation	4%	3%	6%	4%	5%	4%
	Optical semiconductors	5%	5%	10%	7%	5%	9%
	Other semiconductors	19%	16%	18%	13%	7%	5%
	Non-semiconductors	5%	7%	7%	14%	6%	4%
Dicers		100%	100%	100%	100%	100%	100%
Grinders	IC	60%	61%	62%	48%	80%	71%
	Optical semiconductors	6%	1%	8%	11%	5%	6%
	Other semiconductors	27%	31%	19%	22%	9%	11%
	Wafer manufacturing	6%	4%	9%	14%	4%	8%
	Non-semiconductors	2%	3%	3%	6%	2%	4%
Grinders		100%	100%	100%	100%	100%	100%

Shipment Basis

		FY24				FY25	
Product	Application	24-1Q	24-2Q	24-3Q	24-4Q	25-1Q	25-2Q
Dicers	IC	210%	135%	50%	-8%	23%	-7%
	Package singulation	23%	-15%	270%	7%	33%	14%
	Optical semiconductors	-26%	-46%	112%	26%	-5%	50%
	Other semiconductors	-3%	-33%	15%	-48%	-58%	-72%
	Non-semiconductors	-17%	-13%	26%	65%	34%	-54%
Dicers		75%	36%	49%	-10%	7%	-17%
Grinders	IC	160%	68%	73%	-14%	66%	18%
	Optical semiconductors	46%	-86%	-15%	819%	-1%	652%
	Other semiconductors	-16%	-4%	-15%	-37%	-59%	-63%
	Wafer manufacturing	-45%	-62%	79%	26%	-8%	104%
	Non-semiconductors	-50%	-24%	19%	31%	46%	29%
Grinders		37%	11%	34%	-6%	24%	2%

Shipment Basis

		FY24				FY25	
Product	Application	24-1Q	24-2Q	24-3Q	24-4Q	25-1Q	25-2Q
Dicers	IC	20%	-4%	-7%	-14%	62%	-28%
	Package singulation	14%	-34%	119%	-35%	43%	-44%
	Optical semiconductors	10%	-12%	115%	-40%	-16%	40%
	Other semiconductors	-11%	-22%	19%	-37%	-28%	-48%
	Non-semiconductors	-34%	46%	-3%	77%	-47%	-50%
Dicers		8%	-7%	7%	-16%	29%	-29%
Grinders	IC	14%	-2%	18%	-35%	120%	-30%
	Optical semiconductors	402%	-85%	952%	20%	-46%	10%
	Other semiconductors	-17%	10%	-29%	-3%	-46%	-1%
	Wafer manufacturing	-45%	-29%	148%	29%	-59%	56%
	Non-semiconductors	-59%	62%	24%	61%	-55%	44%
Grinders		-1%	-4%	17%	-16%	31%	-20%

Composition by Region

Inspection/Acceptance Basis

Composition by Region	FY2024				FY2025	
	1Q	2Q	3Q	4Q	1Q	2Q
Japan	9%	11%	12%	10%	10%	10%
North America	15%	10%	8%	15%	9%	8%
Asia	69%	72%	74%	66%	75%	75%
Singapore	6%	8%	8%	7%	7%	7%
Taiwan	16%	17%	19%	22%	27%	28%
Korea	14%	12%	9%	9%	9%	10%
China (Note 1)	32%	33%	37%	27%	30%	28%
Other	1%	1%	1%	2%	3%	2%
Europe	7%	7%	5%	9%	6%	7%
Total	100%	100%	100%	100%	100%	100%

Note 1: Including sales to local factories of foreign manufacturers

DISCO believes that striving to increase Mission-achievability connects to increase in our Value-exchangeability and competitiveness, and enables us to respond to the expectations of all capital-market stakeholders.

- ✓ Pursuing Quality of Business
- ✓ Utilization of Tangible Net Worth and Purpose
- ✓ Shareholder Return Policy
- ✓ Action to Implement Management that is Conscious of Cost of Capital and Stock Price

[Click here](#) for more details on our policy regarding the above

These materials

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Notation

The yearly accounting period from April of the current year to March of the following year is denoted by FY (Fiscal Year), and quarterly accounting periods are denoted by 1Q (April – June), 2Q (July – September), 3Q (October – December), and 4Q (January – March). Depending on the monetary unit, figures lower than the minimum unit may be rounded up or down, as a result of which the total sum may not match.

Percentages are calculated based on the actual figures.

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